

AMENDMENTS TO THE CLAIMS

(COMPLIANT WITH THE REVISION TO 37 CFR 1.121)

1. (CURRENTLY AMENDED) A device comprising:

a one-piece outer portion consisting of an electrically insulative material and having dimensions effective ~~(i)~~ to prevent or inhibit plasma arcing to an electrically conductive surface of  
5 an aperture through a wall of a plasma processing chamber aperture and ~~(ii)~~ to fit securely into said plasma processing chamber aperture, said one-piece outer portion further comprising:

(i) a flange section configured to remain outside of said wall ~~plasma processing chamber aperture~~;

10 (ii) a lower section having a shape approximate said aperture to fit into said aperture; and

~~(ii) (iii) an inner opening communicating through the electrically insulative material between a bottom and a top of the outer portion, the inner opening having dimensions effective to~~  
15 ~~enable transmission of any of a physical signal, a gas, a gas mixture and other material through the device.~~

2. (ORIGINAL) A plasma processing chamber having:

at least one aperture therein, the at least one aperture having an exposed electrically conductive surface, and

the device of Claim 1, located inside the aperture.

3. (ORIGINAL) A method of making a plasma processing chamber, the chamber having at least one aperture therein, the at least one aperture having an exposed electrically conductive surface, the method comprising inserting the device of Claim 1 into  
5 the aperture.

4. (CURRENTLY AMENDED) A method of processing a workpiece, comprising the following steps:

(A) exposing the workpiece to a plasma in the plasma processing chamber of Claim 2; and

5 (B) transmitting a ~~physical signal or a gas, gas mixture or other material~~ through the device ~~into or~~ out from the plasma processing chamber.

5. (CURRENTLY AMENDED) A plasma processing chamber having:

a wall;

at least one aperture ~~therein~~ through said wall, the at  
5 least one aperture having an exposed electrically conductive surface, and

a one-piece sleeve inside the aperture, the one-piece sleeve consisting of an electrically insulative material and having:

10 (i) dimensions effective to prevent or inhibit  
plasma arcing to the exposed electrically conductive surface of the  
aperture ~~and to fit securely into the aperture;~~

(ii) a flange section configured to remain outside  
said ~~aperture wall~~;

15 (iii) a lower section having a shape approximate said  
aperture to fit into said aperture; and

~~(iii)~~ (iv) an inner opening communicating through the  
electrically insulative material from a bottom to a top of the one-  
piece sleeve, ~~the inner opening having dimensions effective to~~  
20 ~~enable transmission of any of a physical signal, a gas, a gas~~  
~~mixture and other material through the device.~~

6. (CURRENTLY AMENDED) A method of making a plasma  
processing chamber, ~~the chamber having~~ a wall, the method  
comprising:

(A) forming at least one aperture ~~therein through said~~  
5 wall, the at least one aperture having an exposed electrically  
conductive surface, ~~the method comprising; and~~

(B) inserting a one-piece sleeve into the aperture, the  
one-piece sleeve consisting of an electrically insulative material  
and having:

10           (i)     dimensions effective to prevent or inhibit plasma  
arcing to the exposed electrically conductive surface of the  
aperture ~~and to fit securely into said aperture;~~

          (ii)    a flange section configured to remain outside said  
~~aperture wall;~~

15           (iii) a lower section having a shape approximate said  
aperture to fit into said aperture; and

~~(iii)~~ (iv) an inner opening communicating through the  
electrically insulative material between a bottom and a top of the  
one-piece sleeve, ~~the inner opening having dimensions effective to~~  
20 ~~enable transmission of any of a physical signal, a gas, a gas~~  
~~mixture and other material through the one-piece sleeve.~~

7.     (CURRENTLY AMENDED) The method of Claim 6, further  
comprising, prior to inserting said one-piece sleeve, the step of  
forming said bottom of said one-piece sleeve to a plane having a  
non-orthogonal angle relative to said inner opening ~~match one or~~  
5 ~~more dimensions of said aperture in said chamber.~~

8.     (CURRENTLY AMENDED) A method of processing a  
workpiece, comprising:

          (A)    exposing the workpiece to a plasma in a chamber, the  
chamber having (1) a wall, (2) an ~~at least one aperture therein,~~  
5 ~~the at least one aperture~~ having 1) an exposed electrically

conductive surface through said wall, and ~~2)~~ (3) a one-piece sleeve in the aperture, the one-piece sleeve consisting of an electrically insulative material and having:

10 (i) dimensions effective to prevent or inhibit plasma arcing to the exposed electrically conductive surface of the aperture ~~and to fit securely into said aperture,~~

(ii) a flange section configured to remain outside said aperture wall,

15 (iii) a lower section having a shape approximate a width of said aperture to fit into said aperture; and

~~(iii)~~ (iv) an inner opening communicating through the electrically insulative material between a bottom and a top of the one-piece sleeve, ~~the inner opening having dimensions effective to enable transmission of any of a physical signal, a gas, a gas mixture and other material through the device; and~~

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(B) transmitting ~~any of a physical signal, a gas, a gas mixture and other material~~ through the one-piece sleeve device in to or out from the chamber.

9. (ORIGINAL) A method of operating a plasma processing chamber, wherein the chamber has at least one aperture therein and the aperture has an exposed electrically conductive surface, the method comprising the steps of:

5 (A) initiating a plasma in the chamber, the aperture having the device of Claim 1 therein, then

(B) cleaning the chamber and the device.

10. (ORIGINAL) The method of Claim 9, wherein said plasma exists in said chamber for a predetermined period of time.

11. (CURRENTLY AMENDED) The method of Claim 9, further comprising, prior to step B, the steps of:

exposing a workpiece to the plasma, and

transmitting ~~any of a physical~~ a spectroscopic signal, ~~a gas, a gas mixture and other material~~ through the device ~~into or out from the chamber~~ indicating an etching endpoint.

12. (CURRENTLY AMENDED) The device according to claim 1, wherein ~~said one-piece outer portion further comprises:~~

~~———— a lower section having a first width effective to fit the plasma processing chamber aperture within a predefined tolerance,~~

5 and

said flange section has a ~~second~~ width that is greater than a corresponding width of said ~~plasma processing chamber~~ aperture.

13. (CURRENTLY AMENDED) The device according to claim 12, wherein said device ~~is held in said plasma processing chamber aperture via~~ applies a predetermined amount of pressure against a an inner wall of said aperture.

14. (PREVIOUSLY AMENDED) The device according to claim 12, wherein said lower section has a first length and said flange section has a second length.

15. (CURRENTLY AMENDED) The device according to claim 14, wherein said first length is greater than ~~or equal to~~ a length of said ~~a channel section of said plasma processing chamber aperture.~~

16. (PREVIOUSLY AMENDED) The device according to claim 1, wherein an outer surface of said device forms an angle with reference to the bottom of said device.

17. (ORIGINAL) The device according to claim 16, wherein said angle is non-orthogonal.

18. (CURRENTLY AMENDED) The device according to claim 1, wherein said ~~physical signal comprises~~ inner opening transfers a spectroscopic endpoint detection signal.

19. (ORIGINAL) The plasma processing chamber of claim 2, wherein said at least one aperture comprises an endpoint detection channel.

20. (ORIGINAL) The device according to claim 1, wherein the electrically insulative material is selected from the group consisting of ceramics, multi-crystal ceramics, polyvinyl polymers, polytetrafluoroethylene, polyethylene, polypropylene, polyimides,  
5 polycarbonates and single crystal insulative minerals.